

FEATURES

- Ideal for use in a wide range of home appliance panels
- High degree of inrush current capability
- Precise melting time
- Surface mount technology allows fuses to be directly attached to printed circuit boards
- Notebook Computer Wireless Base Station Networking Telecom System
- Significant savings in weight and real estate
- RoHS/ REACH

RS PRO, Fuse, Ceramic SMD LTCC Chip Fuse, Fast Acting, 1A-5A 63V, 0603

RS Stock No.: 2522124 2522125



RS Professionally Approved Products bring to you professional quality parts across all product categories. Our product range has been tested by engineers and provides a comparable quality to the leading brands without paying a premium price.

Surface Mount Fuse — LTCC Chip Fuse



Product Description

Ceramic SMD LTCC Chip Fuse, Fast Acting, 1A-5A 63V, 0603

Applications:

- Notebook Computer
- Wireless Base Station
- Networking
- Telecom System

General Specifications

| Current Rating | 1A, 1.5A, 2A, 5A |
|-----------------------|------------------|
| Voltage Rating | 63V |
| Body Material | Ceramic |
| Operating Temperature | -55°C to +125°C |
| Country of Origin | Taiwan |

Electrical Characteristics

| | Opening Time | | | | |
|------------------|--------------|-------|---------|----------|--|
| Rated Current | 1 In | 2 In | 3 In | 10 In | |
| current | Min. | Max. | Max. | Max. | |
| 1A-5A | 4 hr | 5 sec | 0.5 sec | 0.02 sec | |

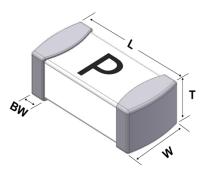
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| Approvals | Marking | Interrupting rating | c RU [®] us | Nominal Cold Resistance (Ohms) | Nominal Melting I ² t (A ² sec.) |
|-----------|---------|------------------------------|-----------------------------|-----------------------------------|--|
| 1A | н | 60A @ 32V DC 35A @ 63V DC | * | 0.2100 - 0.3900 | 0.041 |
| 1.5A | К | | * | 0.0910 - 0.1690 | 0.083 |
| 2A | N | | * | 0.0462 - 0.0858 | 0.098 |
| 5A | т | | * | 0.0084 - 0.0156 | 0.570 |

Shape & Dimension:

| Туре | 0603 |
|------|----------------|
| L | 1.6 ± 0.2 mm |
| W | 0.8 ± 0.2 mm |
| Т | 0.8 ± 0.2 mm |
| BW | 0.36 ± 0.15 mm |



| Recommended Pad Layout | |
|------------------------|---------|
| L1 | 0.66 mm |
| L2 | 0.76 mm |
| w | 1.00 mm |

